

N-channel 100 V, 4.8 mOhm MOSFET with enhanced SOA in LFPAK56E

25 June 2021

Product data sheet

1. General description

N-channel enhancement mode MOSFET in a LFPAK56E package qualified to 175 °C. Part of Nexperia's "ASFETs for hotswap" portfolio, the PSMN4R8-100YSE delivers very low R_{DSon} and a very strong linear-mode (SOA) performance in a high-reliability copper-clip LFPAK56E package. PSMN4R8-100YSE complements the latest "hot-swap" controllers – robust enough to withstand substantial inrush currents during turn-on, low R_{DSon} to minimize I^2R losses delivering optimum efficiency when turned fully ON and an 80% smaller footprint than existing D2PAK types.

2. Features and benefits

- Fully optimized Safe Operating Area (SOA) for superior linear mode operation
- Low R_{DSon} for low I²R conduction losses
- LFPAK56E package for applications that demand the highest performance and reliability in a 30 mm² footprint

3. Applications

- Hot swap
- Load switch
- Soft start
- E-fuse
- Telecommunication systems based on a 48 V backplane/supply rail

4. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C	-	-	100	V
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>	-	-	120	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>	-	-	294	W
Tj	junction temperature		-55	-	175	°C
Static chara	acteristics	· · · · ·	I			_
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 25 A; T _j = 25 °C; Fig. 12	-	3.6	4.8	mΩ
		V _{GS} = 10 V; I _D = 25 A; T _j = 100 °C; Fig. 13	-	5.6	7.7	mΩ
Dynamic ch	naracteristics	· · · · ·	I			_
Q _{GD}	gate-drain charge	I_D = 25 A; V_{DS} = 50 V; V_{GS} = 10 V;	4	15.3	35	nC
Q _{G(tot)}	total gate charge	T _j = 25 °C; <u>Fig. 14; Fig. 15</u>	40	80	120	nC

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Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
Avalanche ruggedness							
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	$ \begin{array}{l} {\sf I}_{D} = 52.6 \; {\sf A}; \; {\sf V}_{sup} \leq \; 100 \; {\sf V}; \; {\sf R}_{GS} = 50 \; \Omega; \\ {\sf V}_{GS} = 10 \; {\sf V}; \; {\sf T}_{j(init)} = 25 \; {\rm ^{\circ}C}; \; unclamped; \\ {\sf t}_{p} = 95 \; \mu {\sf s}; \; \underline{{\sf Fig. 4}} \end{array} $	[1]	-	-	325	mJ
Source-drain diode							
Q _r	recovered charge	$\label{eq:IS} \begin{array}{l} {\sf I}_{\sf S} = 25 \; {\sf A}; \; {\sf dI}_{\sf S} {\sf /dt} = -100 \; {\sf A} {\sf /\mu s}; \; {\sf V}_{\sf GS} = 0 \; {\sf V}; \\ {\sf V}_{\sf DS} = 50 \; {\sf V}; \; {\sf T}_{\sf j} = 25 \; {\rm ^{\circ}C}; \; \underline{{\sf Fig. 18}} \end{array}$		-	40	-	nC

[1] Protected by 100% test

5. Pinning information

Table 2. Pinning information								
Pin	Symbol	Description	Simplified outline	Graphic symbol				
1	S	source						
2	S	source						
3	S	source		D				
4	G	gate						
mb	D	mounting base; connected to drain	LFPAK56E; Power- SO8 (SOT1023)	G H H H H H H H H H H H H H H H H H H H				

6. Ordering information

Table 3. Ordering information

Type number	number Package					
	Name	Description	Version			
PSMN4R8-100YSE		plastic, single-ended surface-mounted package (LFPAK56); 4 leads; 1.27 mm pitch	SOT1023			

7. Marking

Table 4. Marking codes	
Type number	Marking code
PSMN4R8-100YSE	4E8S10J

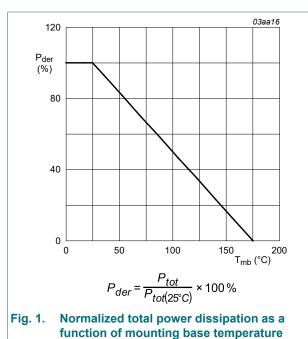
8. Limiting values

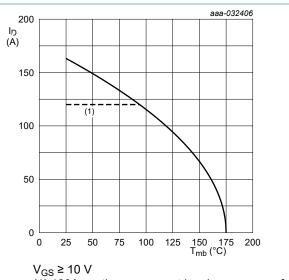
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		-	100	V
V _{DGR}	drain-gate voltage	25 °C ≤ T _j ≤ 175 °C; R _{GS} = 20 kΩ		-	100	V
V _{GS}	gate-source voltage			-20	20	V
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>		-	294	W
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>		-	120	А
l poek (V _{GS} = 10 V; T _{mb} = 100 °C; <u>Fig. 2</u>		-	115	А
I _{DM}	peak drain current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$; Fig. 3		-	653	А
T _{stg}	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
T _{sld(M)}	peak soldering temperature			-	260	°C
Source-drai	n diode	1				_
I _S	source current	T _{mb} = 25 °C		-	120	А
I _{SM}	peak source current	pulsed; t _p ≤ 10 µs; T _{mb} = 25 °C		-	653	Α
Avalanche r	uggedness	1				
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	$ \begin{split} &I_D = 52.6 \text{ A}; \text{V}_{\text{sup}} \leq \ 100 \text{V}; \text{R}_{\text{GS}} = 50 \Omega; \\ &\text{V}_{\text{GS}} = 10 \text{V}; \text{T}_{j(\text{init})} = 25 ^{\circ}\text{C}; \text{ unclamped}; \\ &t_p = 95 \mu\text{s}; \frac{\text{Fig. 4}}{2} \end{split} $	[1]	-	325	mJ
I _{AS}	non-repetitive avalanche current	V_{sup} = 100 V; V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; R _{GS} = 50 Ω; Fig. 4	[1]	-	52.6	A

[1] Protected by 100% test

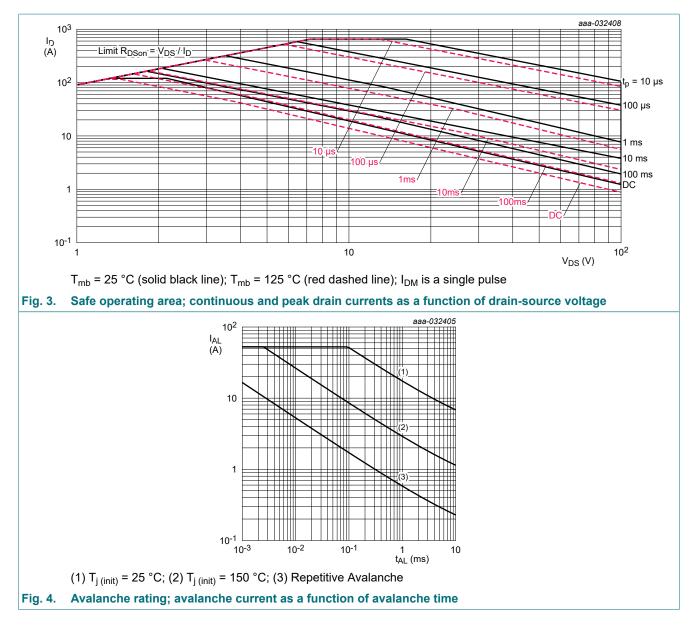




(1) 120A continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.

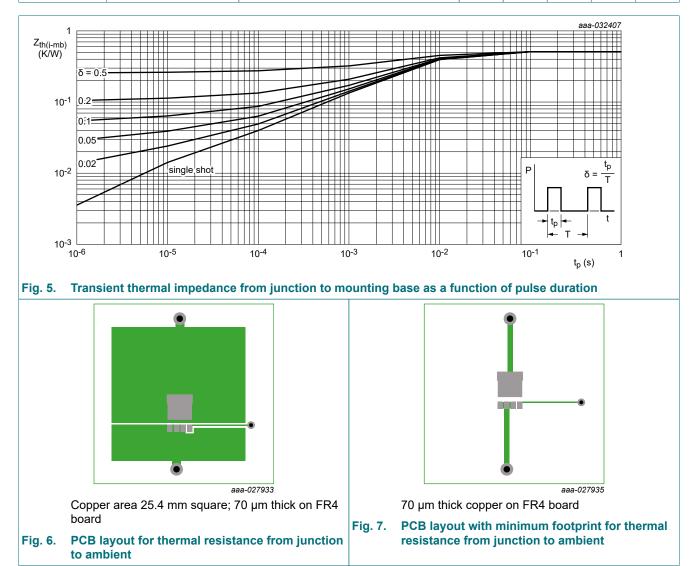
Fig. 2. Continuous drain current as a function of mounting base temperature

PSMN4R8-100YSE



9. Thermal characteristics

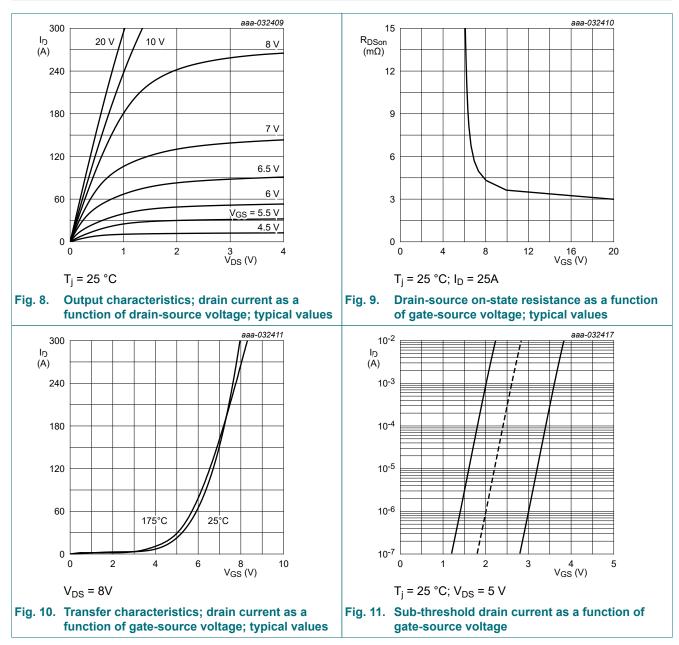
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	<u>Fig. 5</u>	-	0.45	0.51	K/W
R _{th(j-a)}	thermal resistance from	Fig. 6	-	42	-	K/W
	junction to ambient	Fig. 7	-	85	-	K/W

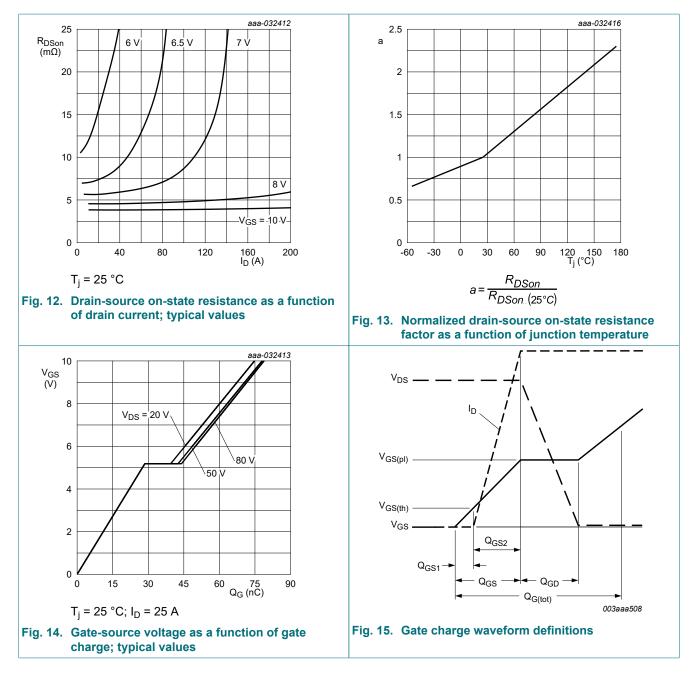


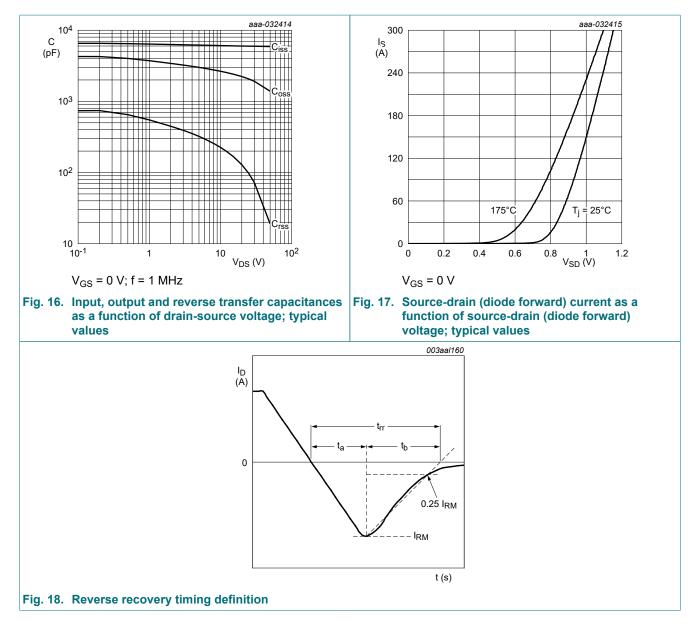
10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static charad	cteristics					
V _{(BR)DSS}	drain-source	I _D = 250 μA; V _{GS} = 0 V; T _i = 25 °C	100	-	-	V
()	breakdown voltage	I _D = 250 μA; V _{GS} = 0 V; T _i = -55 °C	90	-	-	V
V _{GS(th)}	gate-source threshold	I _D = 1 mA; V _{DS} =V _{GS} ; T _i = 25 °C; <u>Fig. 11</u>	2	2.6	3.6	V
	voltage	I _D = 1 mA; V _{DS} =V _{GS} ; T _i = 175 °C	-	1.6	-	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = -55 °C	-	3	-	V
ΔV _{GS(th)} /ΔT	gate-source threshold voltage variation with temperature	25 °C ≤ T _j ≤ 150 °C	-	-6.1	-	mV/K
I _{DSS}	drain leakage current	V _{DS} = 100 V; V _{GS} = 0 V; T _j = 25 °C	-	0.03	1	μA
		V _{DS} = 100 V; V _{GS} = 0 V; T _j = 125 °C	-	15	100	μA
I _{GSS}	gate leakage current	V _{GS} = 20 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
		V _{GS} = -20 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 25 A; T _j = 25 °C; Fig. 12	-	3.6	4.8	mΩ
		V _{GS} = 10 V; I _D = 25 A; T _j = 100 °C; <u>Fig. 13</u>	-	5.6	7.7	mΩ
		V _{GS} = 10 V; I _D = 25 A; T _j = 175 °C; <u>Fig. 13</u>	-	8	11	mΩ
R _G	gate resistance	f = 1 MHz; T _j = 25 °C	0.4	0.83	1.7	Ω
Dynamic cha	aracteristics					
Q _{G(tot)} total gate charge	total gate charge	$ I_D = 25 \text{ A}; V_{DS} = 50 \text{ V}; V_{GS} = 10 \text{ V}; $	40	80	120	nC
		$I_D = 0 \text{ A}; V_{DS} = 0 \text{ V}; V_{GS} = 10 \text{ V};$ $T_j = 25 \text{ °C}$	-	40	-	nC
Q _{GS}	gate-source charge	$I_D = 25 \text{ A}; V_{DS} = 50 \text{ V}; V_{GS} = 10 \text{ V};$	17	29	41	nC
Q _{GS(th)}	pre-threshold gate- source charge	T _j = 25 °C; <u>Fig. 14;</u> <u>Fig. 15</u>	-	16.4	-	nC
Q _{GS(th-pl)}	post-threshold gate- source charge		-	12.6	-	nC
Q _{GD}	gate-drain charge		4	15.3	35	nC
V _{GS(pl)}	gate-source plateau voltage	I _D = 25 A; V _{DS} = 50 V; T _j = 25 °C; Fig. 14; Fig. 15	-	5.2	-	V
C _{iss}	input capacitance	V _{DS} = 50 V; V _{GS} = 0 V; f = 1 MHz;	3550	5920	8290	pF
C _{oss}	output capacitance	T _j = 25 °C; <u>Fig. 16</u>	800	1335	2140	pF
C _{rss}	reverse transfer capacitance		2	19	50	pF
t _{d(on)}	turn-on delay time	$V_{DS} = 50 \text{ V}; \text{ R}_{L} = 2 \Omega; \text{ V}_{GS} = 10 \text{ V};$	-	22	-	ns
t _r	rise time	$R_{G(ext)} = 5 \Omega; T_j = 25 °C$	-	24	-	ns
t _{d(off)}	turn-off delay time	1 –	-	36	-	ns
t _f	fall time	1	-	28	-	ns
Source-drair	diada	·				

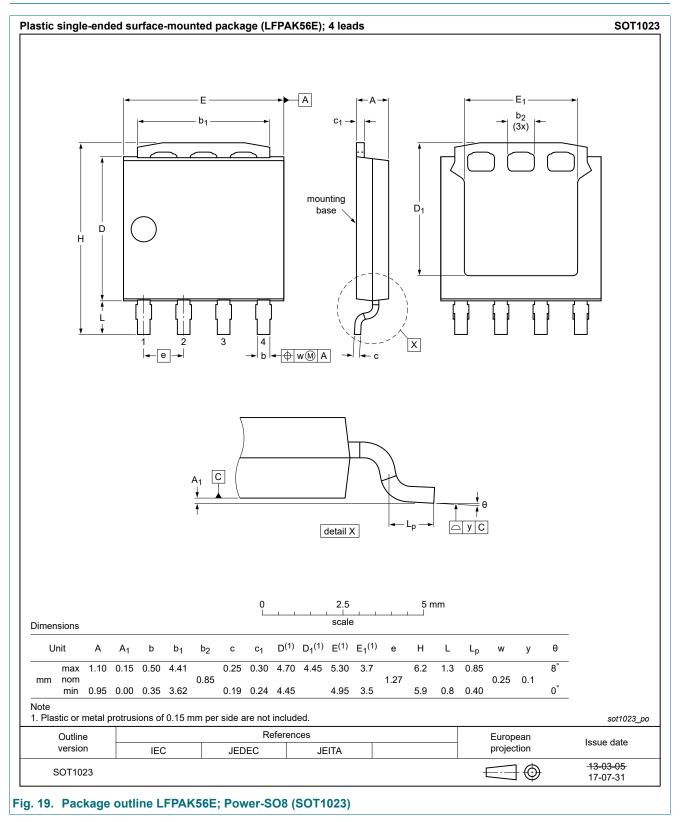
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _{rr}		$I_{S} = 25 \text{ A}; \text{ dI}_{S}/\text{dt} = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V};$	-	40	-	ns
Qr	recovered charge	V _{DS} = 50 V; T _j = 25 °C; <u>Fig. 18</u>	-	40	-	nC



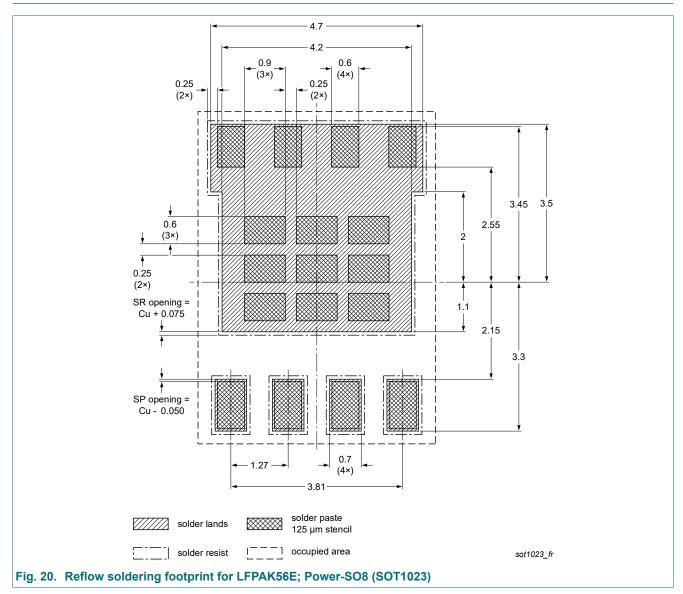




11. Package outline



12. Soldering



13. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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